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PRIOR ART

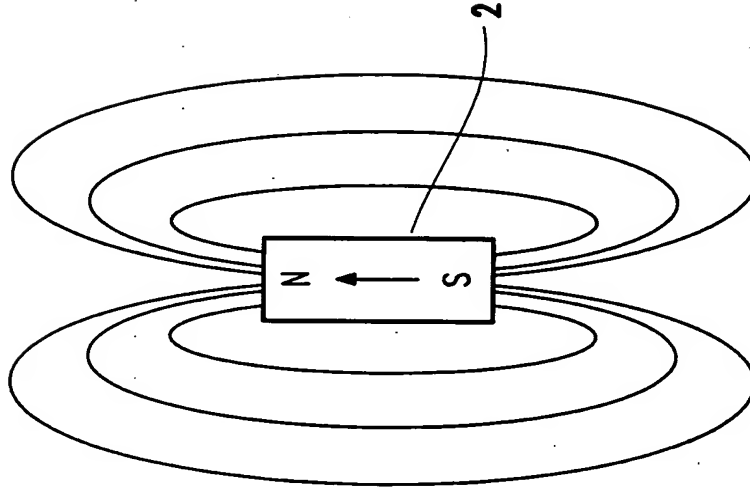


FIG. 1B

PRIOR ART

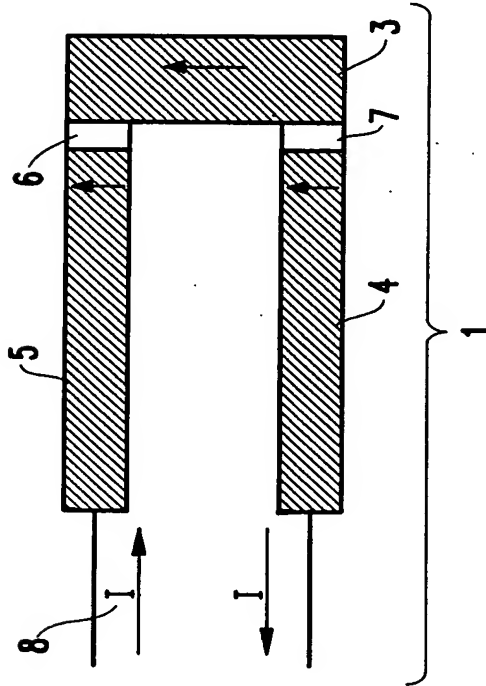


FIG. 1A



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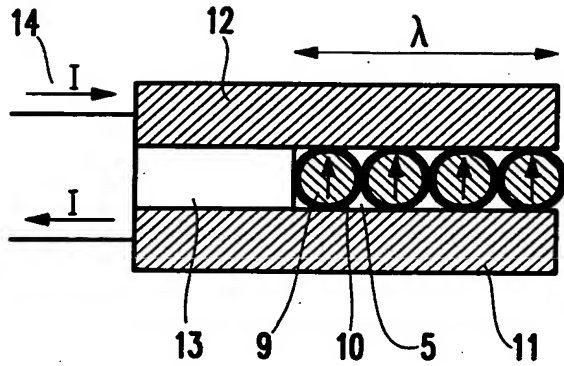


FIG. 2A

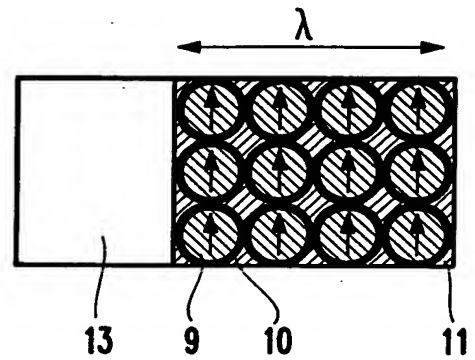


FIG. 2B

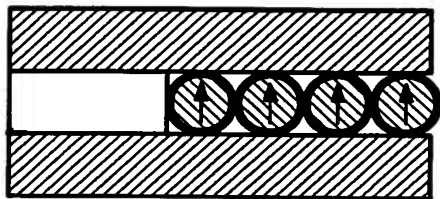


FIG. 2C

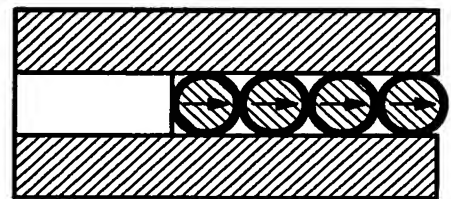


FIG. 2D



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FIG. 3A

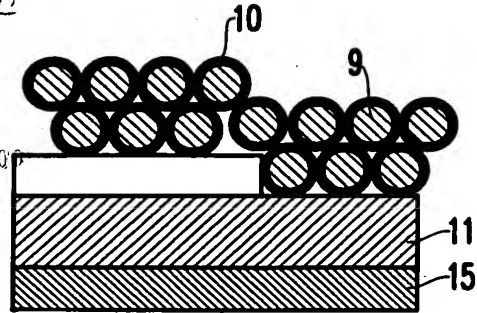


FIG. 3E

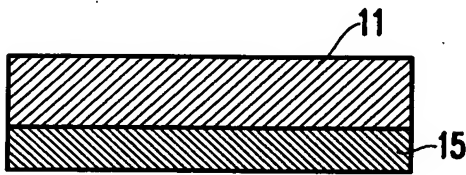


FIG. 3B

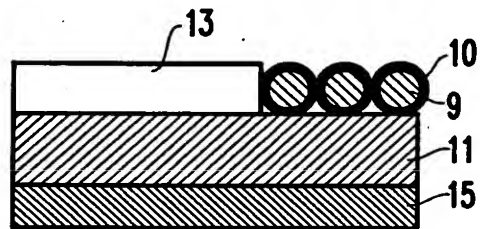


FIG. 3F

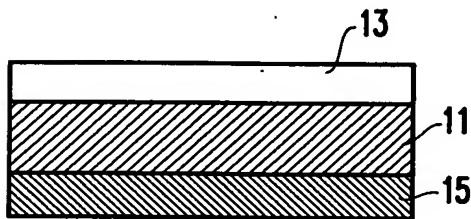


FIG. 3C

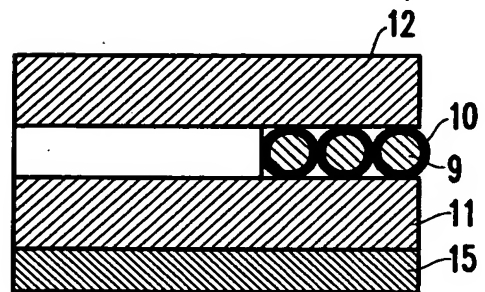


FIG. 3G

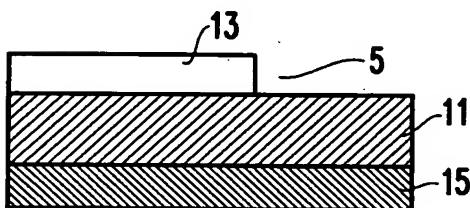


FIG. 3D

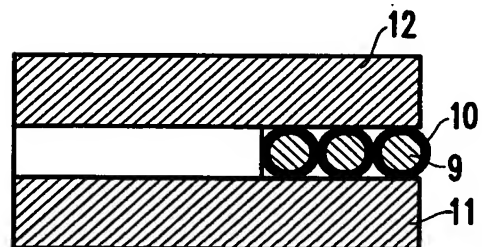


FIG. 3H



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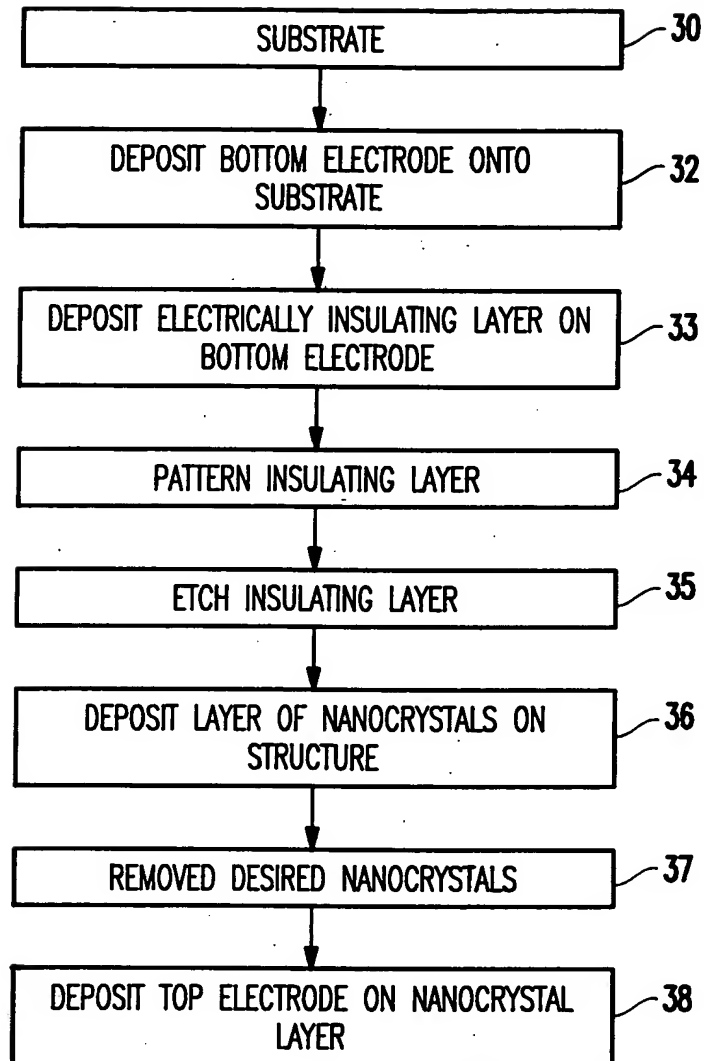


FIG.3I



FIG. 4A

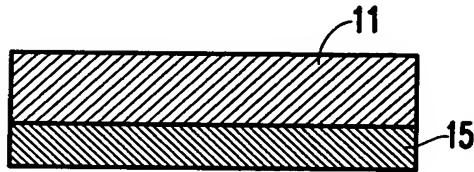


FIG. 4B

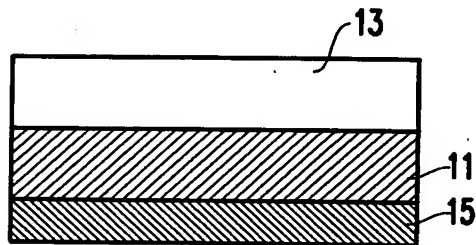


FIG. 4C

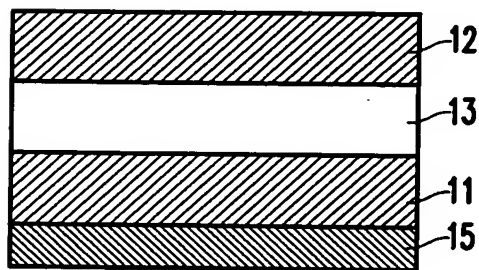


FIG. 4D

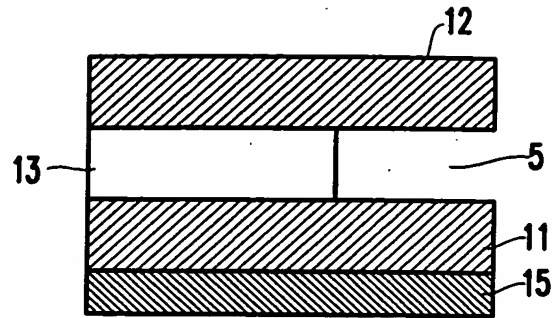


FIG. 4E

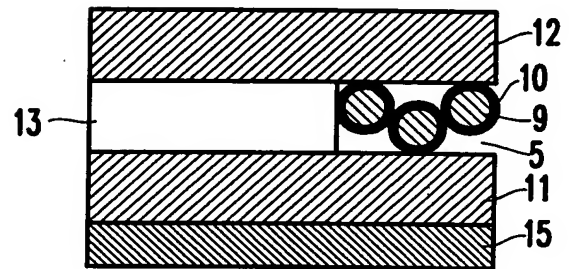


FIG. 4F

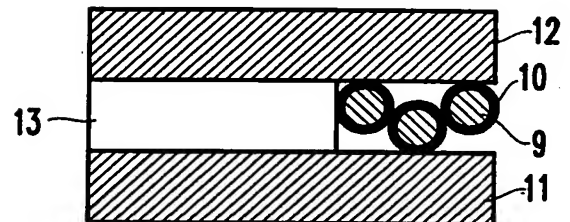


FIG. 4G

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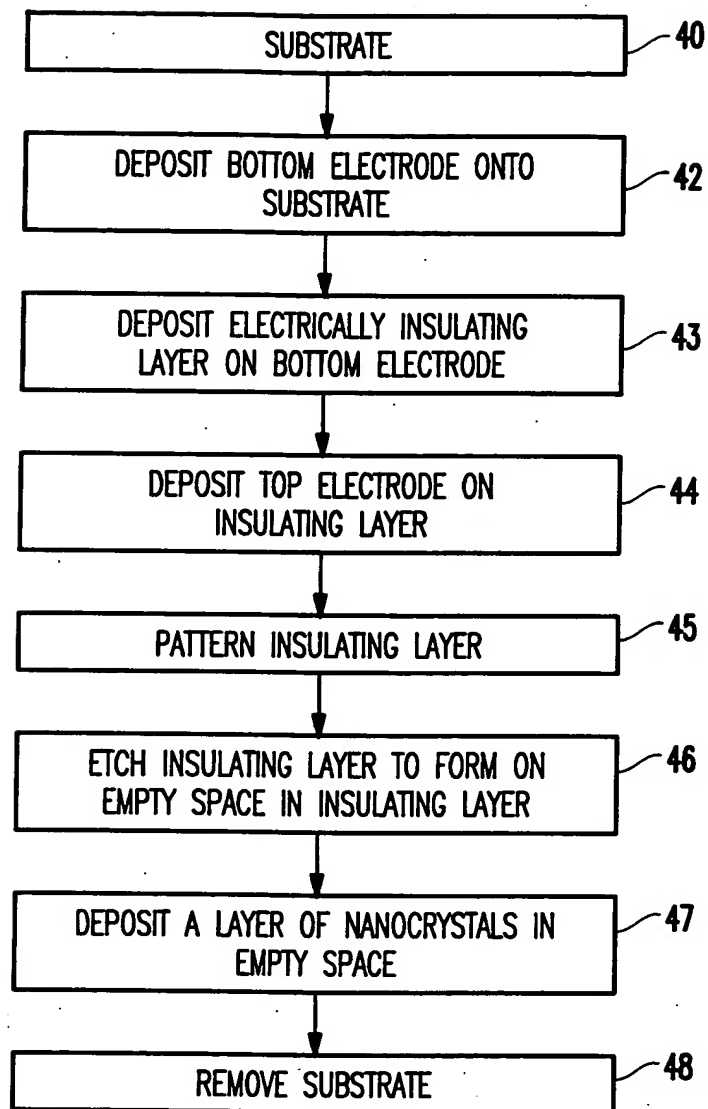


FIG.4H

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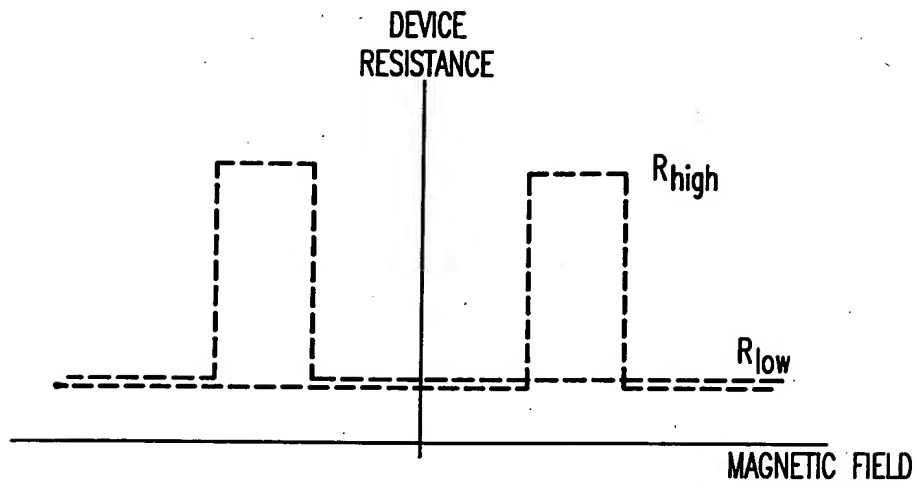


FIG.5A

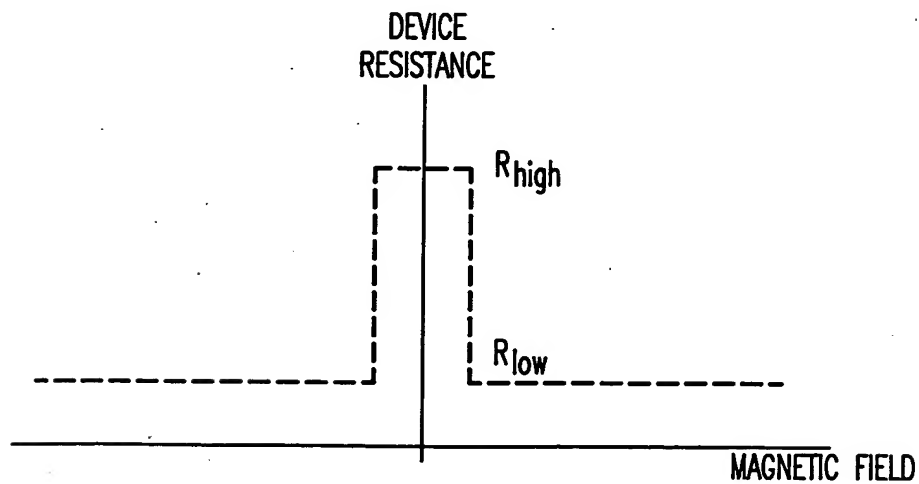


FIG.5B

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